

MHF® 4 Connector

Part No. Plug: 20448-001R Receptacle: 20449-001E-**

Product Specification

Qualification Test Report No. TR-12118

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Rev.	ECN	Date	Prepared by	Checked by	Approved by
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1. Scope

This Product Specification defines the test conditions and the performances of the MHF 4 Connector

2. Product Name and Parts No.

2.1 Product Name

MHF 4 PLUG MHF 4 RECEPTACLE (Pd-Ni)

2.2 Parts No.

Plug: 20448-001R Receptacle: 20449-001E-**

3. Rating

3.1 Applicable Cable

(1) Description	Inner conductor: AWG#36(7/0.05), silver plating annealed copper wire
	Dielectric core: Fluoro-plastics, diameter 0.4(+0.04, -0.02) mm, nominal thickness
	0.125 mm
	Outer conductor: Nominal diameter 0.65mm, silver plating annealed copper wire or tin
	plating annealed copper wire
	Jacket: Fluoro-plastics, diameter 0.81(+0.04, -0.02) mm , nominal thickness 0.08 mm
(2) Requirements	Characteristic impedance: 50(+3,-3) ohm by TDR method
	Nominal capacitance (Reference value): 96pF/m
	Conductor resistance of inner conductor at 293K ($20^{\circ}C$): 1400 ohm/km MAX.
	Insulation resistance: 1000 mega-ohm • km MIN.
	Dielectric withstand voltage: No breakdown at AC1000V for 1 minute.

3.2 Operating Conditions

Voltage: 60V AC (per a contact) Operating temperature: 233K~363KK(-40°C~+90°C)

(Containing temperature rise by current) Nominal characteristic impedance : 50Ω Frequency: DC~9GHz VSWR: PLUG: 1.30 MAX at 0.1~3GHz. 1.50 MAX at 3~6GHz. 2.00 MAX at 6~9GHz. RECEPTACLE: 1.30 MAX at 0.1~3GHz. 1.40 MAX at 3~6GHz. 1.55 MAX at 6~9GHz.

3.3 Storage Conditions

Storage temperature: 248 to 333K(-25°C to 60°C) Storage humidity: 85% max. (Non-condensing)

4. Test and Performance

Test Condition

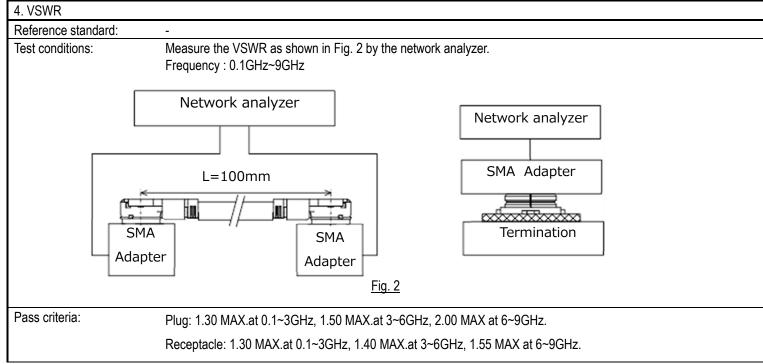
This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202. Temperature... 288K \sim 308K (15°C \sim 35°C) Pressure... 866hPa \sim 1066hPa (650mmHg \sim 800mmHg) Relative humidity... 45 \sim 75%R.H.

1. Contact resistance	
Reference standard:	MIL-STD-202-307
Test conditions:	Solder the receptacle connector to the test board and mate the plug connector together, then, measure the contact resistance as shown in Fig. 1 by the four terminal method. Open circuit voltage : 20mV MAX. Circuit current : 10mA MAX. $\boxed{A} \\ \hline \\ $
Pass criteria:	Main Contact Initial: 20 mΩMAX. After testing: ∠R20 mΩ MAX. Ground contact Initial: 20 mΩ MAX. After testing: ∠R 20 mΩ MAX.

2. Insulation resistance	
Reference standard:	MIL-STD-202-302
Test conditions:	Mate the plug and receptacle connector together, and then apply DC 100 V between the inner contact and the ground contact.
Pass criteria:	Initial: 500 MΩ MIN. After testing: 100 MΩ MIN.

3. Dielectric withstanding voltage	
Reference standard:	MIL-STD-202-301
Test conditions:	Mate the plug and receptacle connector together, then, apply AC 200 V rms between the inner contact and the
	ground contact for a minute.
Pass criteria:	No creeping discharge, flashover, no insulator breakdown shall occur.

4.1. Electrical Performance



4.2. Mechanical Performance

1. Un-mating force	
Reference standard:	-
Test conditions:	Solder the receptacle connector to the test board and mate the plug connector together then, measure the un- mating force at speed of 25±3mm/minutes in parallel with the mating axis by the push-pull machine.
Pass criteria:	Initial: 4 N MIN. 30cycles: 2 N MIN.

2. Crimp strength	
Reference standard:	-
Test conditions:	Pull the cable as shown in Fig. 3 at speed of 25±3mm/minutes by the tensile strength machine and measure the retention force.
	<u>Fig. 3</u>
Pass criteria:	5 N MIN.

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4.2. Mechanical Performance

Durability	
Reference standard:	-
Test conditions:	Mate and un-mate the receptacle connector (soldered to the test board) and plug connector 30cycles at speed of 25±3mm/minutes in parallel with the mating axis by the push-pull machine.
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur. [Contact Resistance] Shall meet 4.1.1.

4. Cable retention force Reference standard: Test conditions: Apply force to the cable as shown in Fig. 4. During the testing, run 100mA DC to check electrical discontinuity. Prohibited → 2 N MAX. Fig. 4 Prohibited Pass criteria: [Appearance] No abnormality adversely affecting the performance shall occur.

5. Vibration		
Reference standard:	-	
Test conditions:	Apply the following vibration to the mating connector.	
	During the testing, run 100mA DC to check electrical discontinuity.	
	Frequency: $10Hz \rightarrow 10Hz \rightarrow 10Hz$ / approx 20minutes.	
	Half amplitude, Peak value of acceleration: 1.5mm or 59m/s2 (6G)	
	Directions, cycle: 3 mutually perpendicular direction, 3 cycles for each direction.	
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur	
	[Contact Resistance] See 4.1.1.	
	[Electrical discontinuity] No electrical discontinuity greater than 1µs.	

6.Shock		
Reference standard:	MIL-STD-202-213, Condition B.	
Test conditions:	Apply the following shock to the mating connector. During the testing, run 100mA DC to check electrical discontinuity.	
	Peak value of acceleration: 735m/s2 (75G)	Directions: 6 mutually perpendicular direction Cycle: 3 cycles about each direction
	Duration: 11msec Wave Form: Half Sinusoidal	
Pass criteria:	[Appearance] No abnormality adversely affecti [Contact Resistance] See 4.1.1. [Electrical discontinuity] No electrical discontin	

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4.3. Environmental Performance

1. Humidity(Steady state	
Reference standard:	MIL-STD-202-103, Condition B.
Test conditions:	Apply the following environment to the mating connector.
	Temperature: 313±2K (40±2°C)
	Humidity: $90\sim95\%$ RH
	Duration: 96 hours
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur
	[Contact Resistance] See 4.1.1.
	[Insulation Resistance] See 4.1.2.
	[Dielectric Withstanding Voltage] See 4.1.3.

2. Thermal shock	
Reference standard:	MIL-STD-202-107G, Condition A.
Test conditions:	Apply the following environment to the mating connector.
	Temperature: 218K(-55°C),30min. ⇔ 358K(85°C),30min.
	Transition time: 5min. MAX.
	No. of cycles: 5 cycles
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur
	[Contact Resistance] See 4.1.1.
	[Insulation Resistance] See 4.1.2.
	[Dielectric Withstanding Voltage] See 4.1.3.

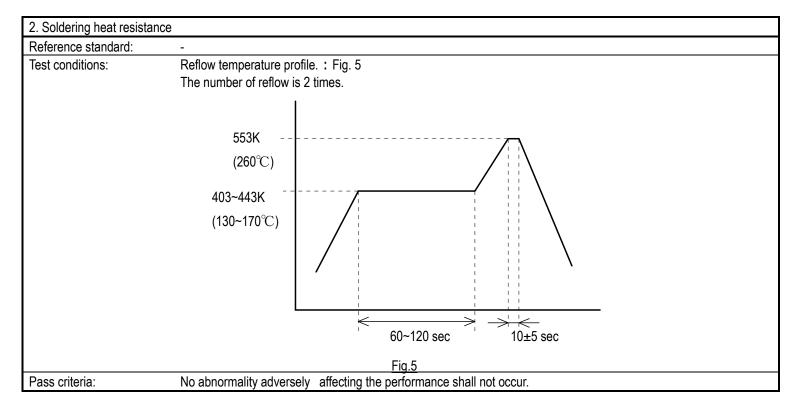
3. High temperature life	
Reference standard:	-
Test conditions:	Apply the following environment to the mating connector. Temperature: 363±2K (90±2°C) Duration: 96 hours
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur [Contact Resistance] See 4.1.1.

4. H2S gas									
Reference standard:	-								
Test conditions:	Apply the following environment to the mating connector.								
	Temperature : 313±2K (40±2°C)								
	Relative Humidity : 80±5%RH								
	Gas : H ₂ S 3±1ppm								
	Duration : 96 hours								
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur								
	[Contact Resistance] See 4.1.1.								

5. Salt water spray								
Reference standard:	MIL-STD-202-101E, Condition B							
Test conditions:	Apply the following environment to the mating connector.							
	Temperature: 308±2K (35±2°C)							
	Salt water density: 5±1% [by weight]							
	Duration: 48 hours							
Pass criteria:	[Appearance] No abnormality adversely affecting the performance shall occur							
	[Contact Resistance] See 4.1.1.							

4.4. Others

1. Solder ability	
Reference standard:	MIL-STD-202-208E
Test conditions:	Dip the solder tine of the contact in the solder bath at 518±5K (245±5°C) for 5±0.5seconds after immersing the tine in the flux of RMA type for 5 to 10 seconds.
Pass criteria:	More than 95% of the dipped surface becomes wet and the pinhole that should not gather at one point is less than 5%.



4.5 Test Sequence and Specimen Quantity

-									Group							
Test Item		Α	В	С	D	E	F	G	Н	J	К	L	М	Ν	Р	Q
Contact Resistance						1, 3		1, 3	1, 3	1, 5	1, 5	1, 3	1, 3	1, 3		
Insulation Resistance										2, 6	2, 6					
D. W. Voltage		1								3, 7	3, 7					
VSWR			1													
Unmating Force				1												
Crimp strength					1											
Durability						2										
Cable Retention Force							1									
Vibration								2								
Shock									2							
Humidity (Steady State)										4						
Thermal Shock											4					
High Temperature Life												2				
H2S Gas													2			
Salt Water Spray														2		
Solder ability															1	
Soldering Heat Resistance																1
Sample Quantity	Plug	10	10	10	10	10	10	10	10	10	10	10	10	10	-	-
(pcs.) Receptacle		10	5	10	-	10	IU	IU	10	10	10	10	10	10	10	10

Table 1 Test Sequence and Sample Quantity

*Numbers indicate sequence in which tests are performed.

5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.